Applicant/Grantee Microchip Technology Inc.					
FCC ID: 2ADHKWFI32E01					
Section 15.212 Modular Transmitters / X Request for Modular Approval Request for Limited Modular Approval					
X	Request for MG		Device Conditions	Comply (V/N)	
		Requirements Single Modular	Approval Requirements	Comply (Y/N)	
1	frequency circ Physical/disc may be locate	ments must have the radio cuitry must be shielded. rete and tuning capacitors ed external to the shield, but e module assembly.	The module has its own RF shielding. Shield Can is employed on the board structure, please see exhibition External Photo, the emission measurement was conducted without further shielding added.	Y	
2	modulation/d provided) to e comply with t applicable RS	hall have buffered ata input(s) (if such inputs are ensure that the module will the requirements set out in the S standard under conditions data rates or over-modulation	integrated on the RF chip	Y	
3	supply regula ensure that th the requirement standard regat power supply device which Requirements standard regat design of the	hall have its own power tion on the module. This is to be module will comply with ents set out in the applicable rdless of the design of the ing circuitry in the host houses the module. It is set out in the applicable rdless of the power supplying circuitry in the which houses the module.	RF System on Chip IC contains multiple dedicated voltage regulators for transmitter chain including modulator, pre-power amplifier. Output power is controlled by the RF Chip and de-coupled from supply voltage variations.	Y	
4	provisions for and antennas Equipment ce contain a deta	hall comply with the external power amplifiers detailed in this standard. The extification submission shall ailed description of the of all antennas that will be module.	Module Variants have below antenna approaches: #1 The Antenna is part of the module #2 Include different antenna assy. in the list, it is connected by an u.FL connector based cable to EUT.	Υ	
5	with the appli alone configu	hall be tested for compliance cable standard in a stand- ration, i.e. the module must another device during testing	stand-alone configuration. See Setup Photos.	Y	
6	Category I eq	hall comply with the uipment labelling	In the exhibition OEM manual, there are Instructions given to the OEM on how to label the end product. See Label Exhibit.	Y	

7	The modular transmitter complies with all specific rules or operating requirements that ordinarily apply to a complete transmitter and the manufacturer will provide adequate instructions along with the module to explain any such requirements. A copy of these instructions is included in this application for equipment authorization:	Instructions in User Manual	Y
8a	Address compliance with the Commission's RF exposure limits in Sections 1.1310 and 2.1093. In addition, spread spectrum transmitters operating under Section 15.247 are required to address RF exposure compliance in accordance with Section 15.247(b)(4).	Please refer the Maximum Permissible Exposure Information.	Y

A **limited modular approval** may be granted for single or split modular transmitters that do not comply with all of the above requirements, *e.g.*, shielding, minimum signaling amplitude, buffered modulation/data inputs, or power supply regulation, if the manufacturer can demonstrate by alternative means in the application for equipment authorization that the modular transmitter meets all the applicable Part 15 requirements under the operating conditions in which the transmitter will be used. Limited modular approval also may be granted in those instances where compliance with RF exposure rules is demonstrated only for particular product configurations. The applicant for certification must state how control of the end product into which the module will be installed will be maintained such that full compliance of the end product is always ensured.

Signature

Name/Title: Steve Caldwell / Vice President Company Name: Microchip Technology Inc.

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Date: June 30, 2021